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edoardo.bonizzoni@unipv.it

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Hangzhou Dianzi University, China
jwcao@hdu.edu.cn

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National Chiao Tung University, Taiwan
khchen@faculty.nctu.edu.tw

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acilardo@unina.it

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gordana@ieeec.org

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University of Sharjah, UAE
elwakil@ieeec.org

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fayed.1@osu.edu

YAJUN HA
ShanghaiTech University, China
hayj@shanghaitech.edu.cn

ALEX JAMES
Nazarbayev University, Kazakhstan
apj@ieeec.org

IZZET KALE
University of Westminster, UK
kalei@westminster.ac.uk

HAMID REZA KARIMI
Politecnico di Milano, Italy
hamidreza.karimi@polimi.it

MEHRAN MOZAFFARI KERMANI
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mehran2@usf.edu

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Tufts University, USA
vkoomson@ece.tufts.edu

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nagendra@ee.iitm.ac.in

FADI J. KURDAHI
University of California
Irvine, California, USA
kurdahi@uci.edu

TAI-CHENG LEE
National Taiwan University, Taiwan
tee@ntu.edu.tw

PIETRO DE LELLIS
University of Naples Federico II,
Italy
pietro.delellis@unina.it

CHANGZHI LI
Texas Tech University, USA
changzhi.li@ttu.edu

XIAO LIU
University College London, UK
xiao@ucl.ac.uk

JASWINDER LOTA
University of East London, UK
j.lota@uel.ac.uk

PAOLO MAFFEZZONI
Politecnico di Milano, Italy
paolo.maffezzoni@polimi.it

MAURIZIO MARTINA
Politecnico di Torino, Italy
maurizio.martina@polito.it

GUIDO MASERA
Politecnico di Torino, Italy
guido.masera@polito.it

PRAMOD KUMAR MEHER
Nanyang Technological University,
Singapore
pkmehar@gmail.com

PHILIP K. T. MOK
The Hong Kong University of Science and
Technology, Hong Kong
cemok@ust.hk

ANGELO NAGARI
STMicroelectronics, France
angelo.nagari@st.com

FILIPPO NERI
u-blox AG, Switzerland
filippo.neri@bluewin.ch

ALBERTO OLIVERI
University of Genoa, Italy
alberto.oliveri@unige.it

MARVIN ONABAJO
Northeastern University, USA
monabajo@ece.neu.edu

YU PU
Qualcomm Research Center, USA
yup@qti.qualcomm.com

ROBERT RIEGER
National Sun Yat-sen University,
Taiwan
rrieger@mail.nsysu.edu.tw

PIETER ROMBOUTS
Ghent University, Belgium
pieter.rombouts@elis.ugent.be

GIOVANNI RUSSO
IBM Research Ireland, Ireland
grusso@ie.ibm.com

HENRIK SJOLAND
Ericsson, Sweden
henrik.sjoland@ericsson.com

PAUL SOTIRIADIS
National Technical University Athens,
Greece
pps@mail.ntua.gr

NAN SUN
University of Texas at Austin, USA
nansun@mail.utexas.edu

YICHUANG SUN
University of Hertfordshire, UK
y.sun@herts.ac.uk

ZHICHAO TAN
Analog Devices, USA
zhichao.tan@analog.com

ESTEBAN TLELO-CUAUTLE
INAOE, Mexico
etlelo@inaoep.mx

SARA VINCO
Politecnico di Torino, Italy
sara.vinco@polito.it

ZHIHUA WANG
Tsinghua University, China
zhihua@tsinghua.edu.cn

APISAK WORAPISHET
Mahanakorn University of Technology,
Thailand
apisak@mut.ac.th

YAJUN YU
Southern University of Science and
Technology of China,
China
yuyj@sustc.edu.cn

HENG ZHANG
Broadcom Corporation, USA
heng@broadcom.com

XINMIAO ZHANG
The Ohio State University, USA
zhang.8952@osu.edu

WEISHENG ZHAO
Beihang University, China
weisheng.zhao@buaa.edu.cn

DOMENICO ZITO
Aarhus Universitet, Denmark
domenico.zito@eng.au.dk

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